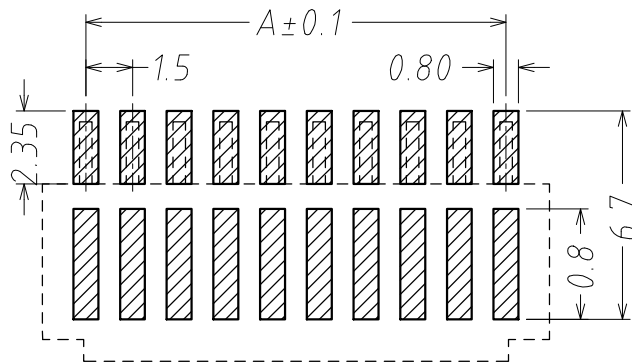
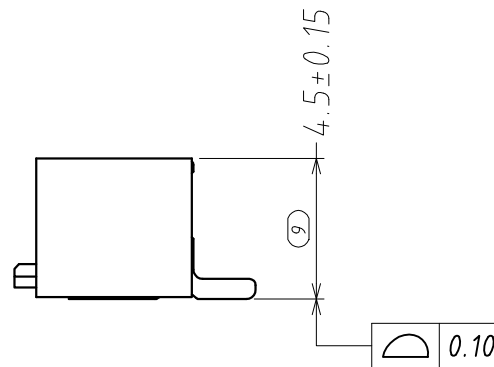
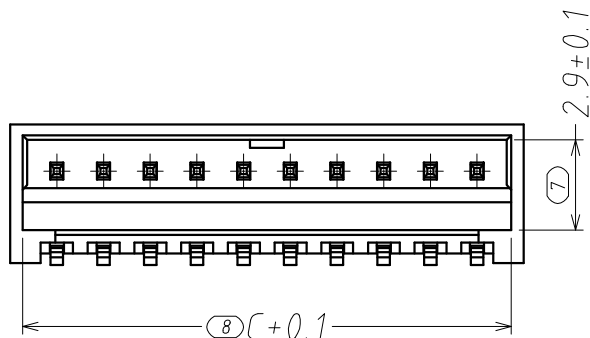
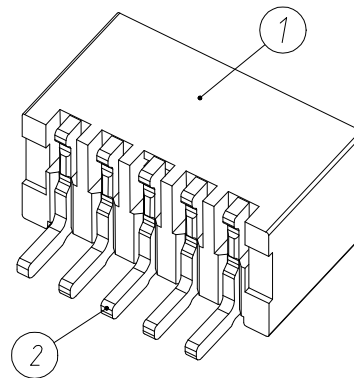
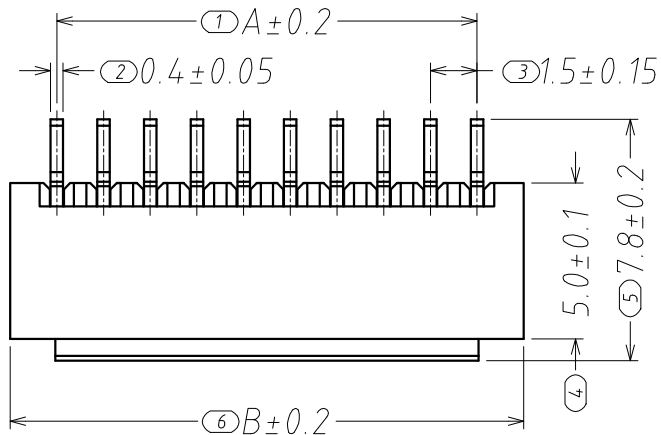


REV.	ECN NO.	LOCAS.	DESCRIPTION	DATE	DESIGN
A			NEW DRAWING		



SUGGESTED PCB LAYOUT
(COMPONENT SIDE)

技术参数:

- 1、所有材料符合ROHS2.0/REACH/HF要求。
- 2、额定电流: 3A, AC, DC;
- 3、额定电压: 350V, AC, DC;
- 4、温度范围: -25℃~+85℃;
- 5、接触电阻: $\leq 0.02\Omega$;
- 6、绝缘电阻: $\geq 1000M\Omega$;
- 7、耐压: 500V, AC/minute.
- 8、产品料号:

A15003 - n AWB - 03 T1

孔位

产品类型

AWB: 卧贴针座

电镀

T1: 镀亮锡

胶芯材质

03: LCP 本色

Circuits	Dimensions(mm)		
	A	B	C
2	1.50	4.50	3.70
3	3.00	6.00	5.20
4	4.50	7.50	6.70
5	6.00	9.00	8.20
6	7.50	10.50	9.70
7	9.00	12.00	11.20
8	10.50	13.50	12.70
9	12.00	15.00	14.20
10	13.50	16.50	15.70
11	15.00	18.00	17.20
12	16.50	19.50	18.70
13	18.00	21.00	20.20
14	19.50	22.50	21.70

2	端子 Contact	黄铜 Brass	n*1	电镀(锡): 整个表面镀底银30u"MIN, 再镀锡80u". MIN.
1	基座 Wafer	LCP (UL94V-0)	1	本色
序号	名称	材料	数量	附注

DESIGN:	Xiping Huang				广东国连电子有限公司 GUANGDONG GUOLIAN ELECTRONICS CO., LTD			
CHECK:	Ke Tian							
APPROVED:	Youquan Xu			TITLE:	MX1. 5贴片			
DIM	TOL	DIM	TOL	PART NO.	A15003-nAWB-03T1			
X.	±0.25							
X. X	±0.20	X° .	±3.0°	REV. A	SCALE: N/A	UNIT: mm	SHEET: 1/1	 
X. XX	±0.15	X. X°						
X. XXX		X. XX°						